

\*Customer:

**Pb Free**

# SPECIFICATION

<b>ITEM</b>	<b>CHIP LED DEVICE</b>
<b>MODEL</b>	<b>TWH104-H#</b>
<b>REVISION DATE</b>	<b>Rev0.2(061026)</b>

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Drawn by	Checked by	Approved by



## 1. Features

- Package : 1.6 × 0.8 × 0.4 mm
- Color coordinates: X = 0.29 Y = 0.28 according to CIE 1931
- Tape and reel packing

## 2. Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Value	Unit
Power Dissipation	$P_d$	70	mW
Forward Current	$I_F$	20	mA
Peak Forward Current	$I_{FM}^{*1}$	60	mA
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	-30 ~ 80	°C
Storage Temperature	$T_{stg}$	-40 ~ 100	°C

\*1  $I_{FM}$  conditions: Pulse width  $T_w \leq 0.1ms$ , Duty ratio  $\leq 1/10$

## 3. Electro-Optical Characteristics

(Ta=25°C)

Characteristics	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	$V_F$	$I_F=5mA$	2.7	2.9	3.1	V
Zener Forward Voltage	$V_{F(Z)}$	$I_F=10mA$	0.6	0.8	1.5	V
Luminous Intensity <sup>*2</sup>	$I_v$	$I_F=5mA$	100	150	220	mcd
Chromaticity Coordinates <sup>*3</sup>	X	$I_F=5mA$	0.230	0.275	0.321	
	Y	$I_F=5mA$	0.220	0.265	0.310	
Viewing angle <sup>*3</sup>	$\Delta 1/2\theta$	$I_F=5mA$	-	160	-	°

\*2 The luminous intensity  $I_v$  is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.

\*3 The CIE standard colorimetric system

[Note] (Tolerance :  $I_v \pm 10\%$ , color coordinate  $\pm 0.01$ ,  $V_F \pm 0.1$ )

#### 4. Ranks

(1) Luminous Intensity:  $I_v$  [mcd]

Rank	$I_v$ [mcd]	Condition
C	100~150	IF =5mA
D	150~220	

(2) Color Coordinate: x, y

Rank	A				Condition
x	0.230	0.270	0.285	0.245	IF=5mA
y	0.220	0.220	0.250	0.250	

Rank	B				Condition
x	0.245	0.285	0.303	0.263	IF=5mA
y	0.250	0.250	0.280	0.280	

Rank	C				Condition
x	0.263	0.303	0.281	0.321	IF=5mA
y	0.280	0.280	0.310	0.310	

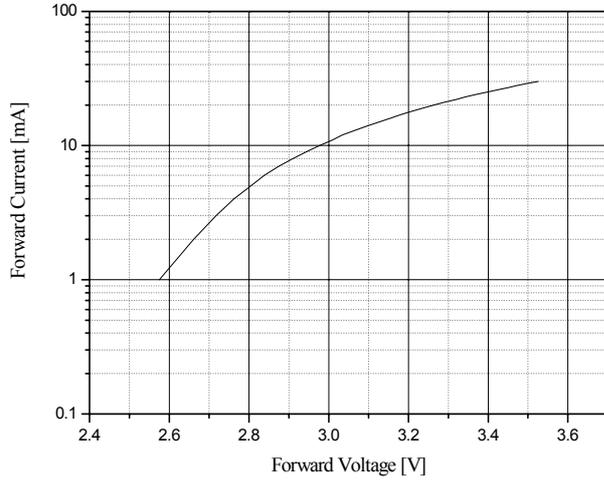
Rank	D				Condition
x	0.281	0.321	0.340	0.300	IF=5mA
y	0.310	0.310	0.340	0.340	

(3) Forward voltage:  $V_F$

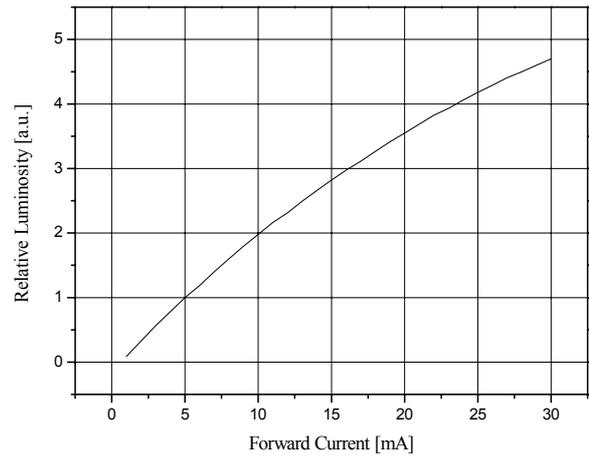
Rank	$V_F$ (V)		Condition
A	2.7	2.8	IF = 5mA
B	2.8	2.9	
C	2.9	3.0	
D	3.0	3.1	

## 5. Characteristic Diagram

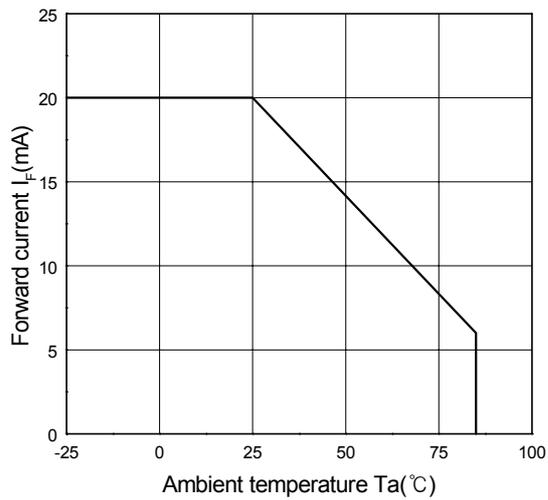
Forward Current vs. Forward Voltage



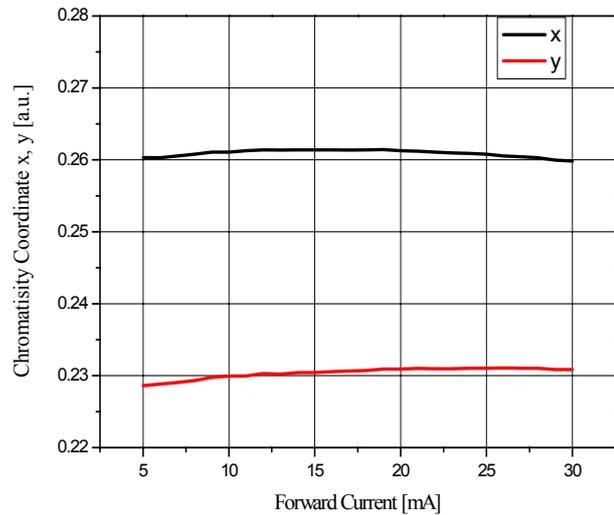
Luminous Intensity vs. Forward Current



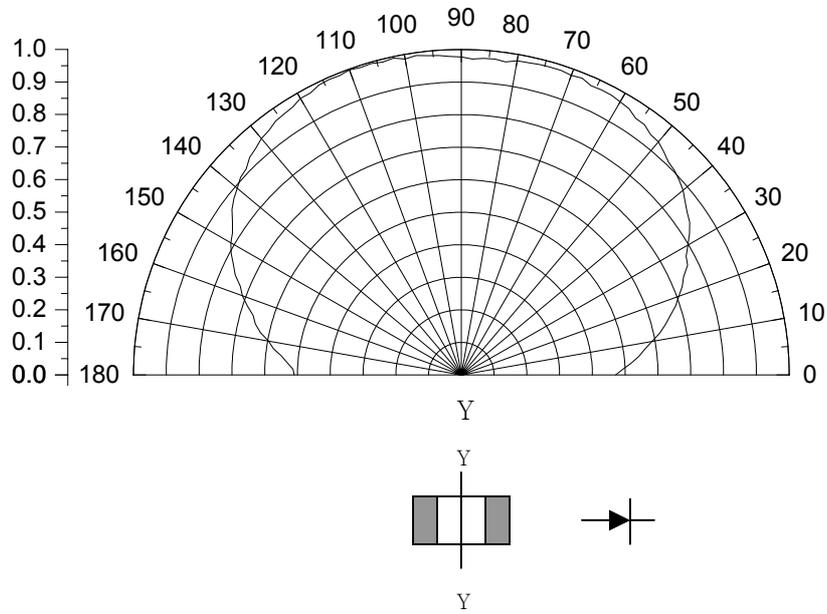
Forward Current Derating Curve



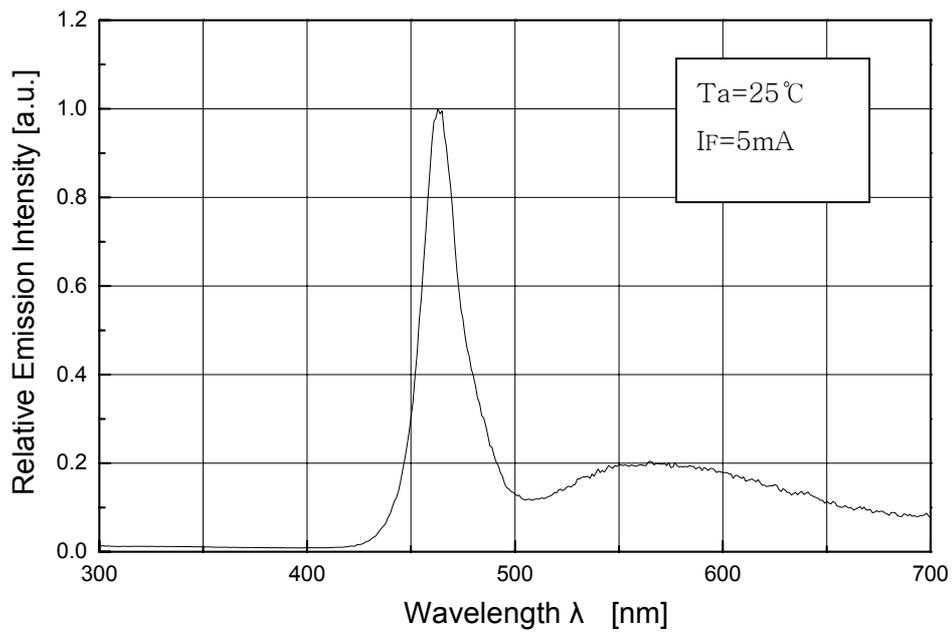
Forward Current vs Chromaticity Coordinate



Radiation Diagram



Spectrum



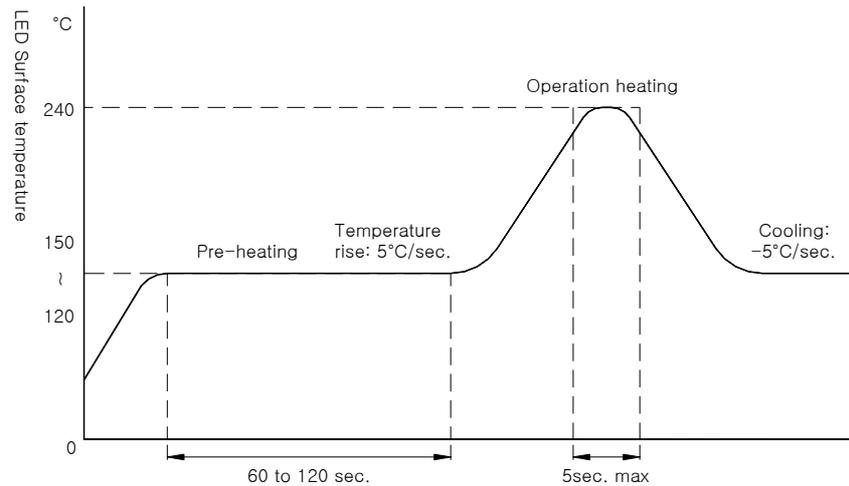
## 6. Soldering Profile

### Reflow Soldering Conditions/ Profile

#### (1) Lead Solder

-Preliminary heating to be at 150°C max. for 2 minutes max.

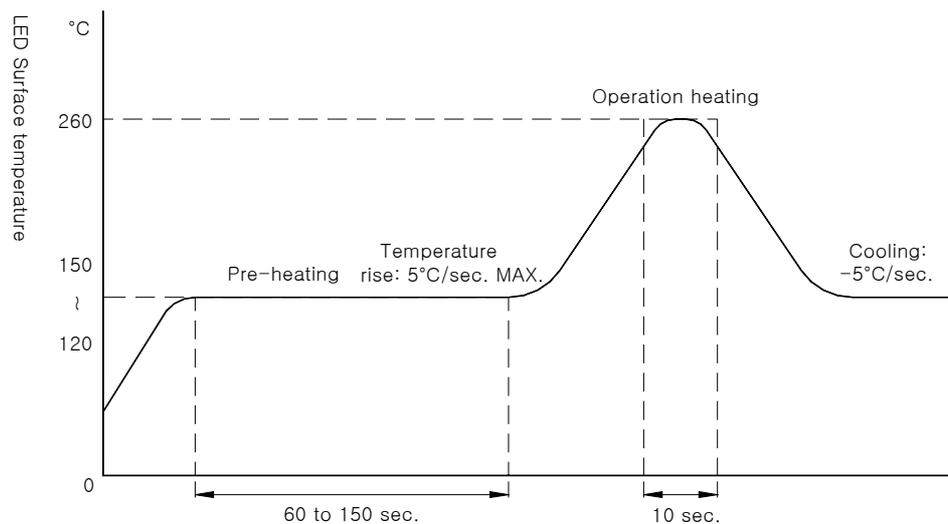
-Soldering heat to be at 240°C max. for 5 seconds max.



#### (2) Lead-Free Solder

-Preliminary heating to be at 150°C max. for 2 minutes max.

-Soldering heat to be at 260°C max. for 10 seconds max.

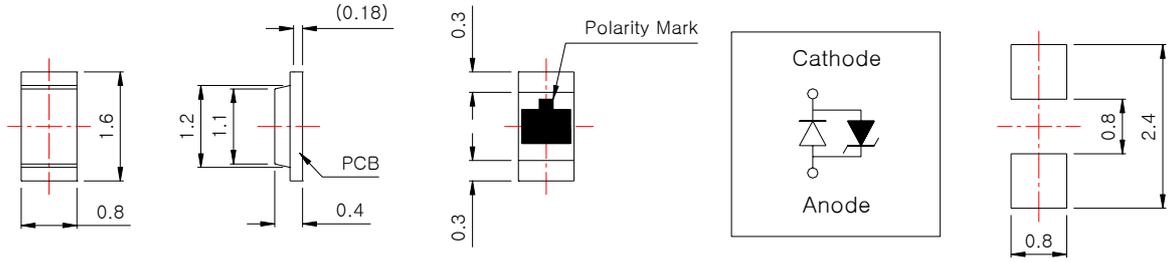


#### (3) Hand Soldering conditions

-Not more than 3 seconds @MAX280°C, under Soldering iron.

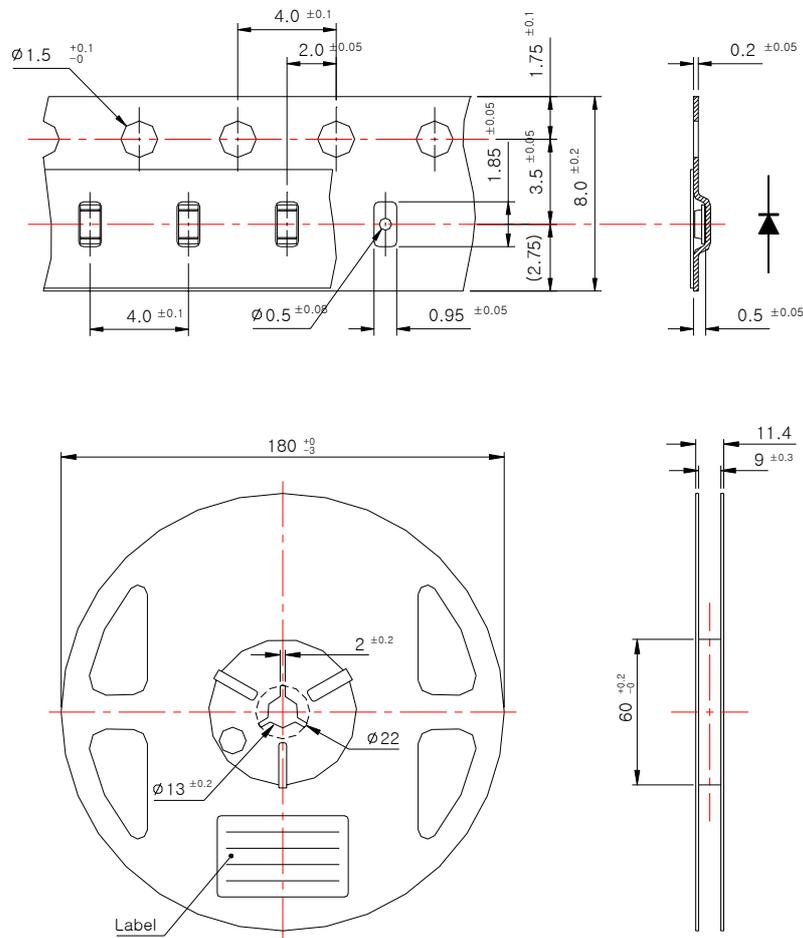
## 7. Outline Dimension

Tolerance:  $\pm 0.1$ , Unit: mm



[Recommended Solder Pattern]

## 8. Packing

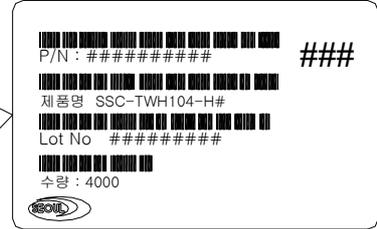
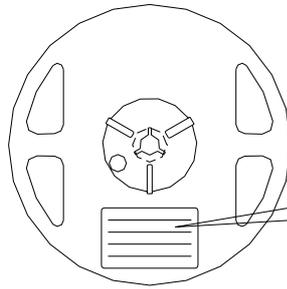


Tolerance  $\pm 0.2$ , Unit : mm

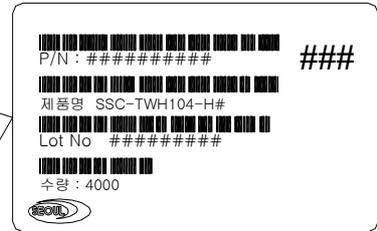
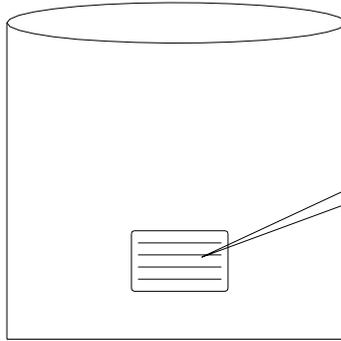
- (1) Quantity : 4000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2$ mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at  $10^\circ\text{C}$  angle to be the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

**9. Reel Packing Structure**

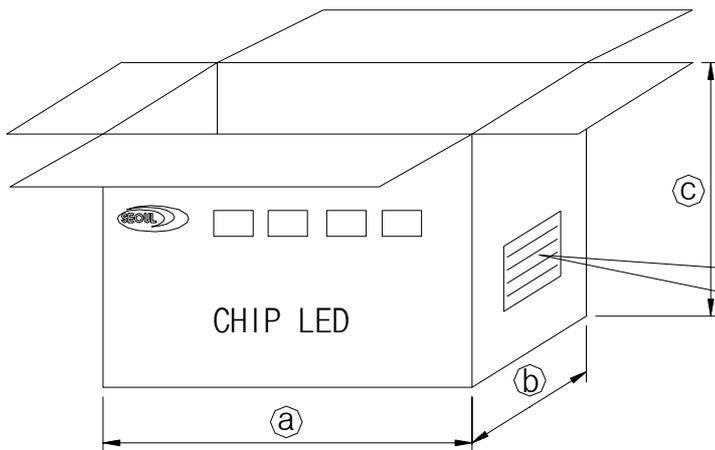
Reel



Aluminum Vinyl Bag

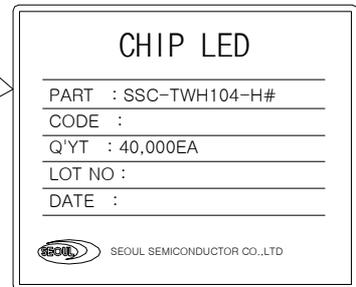


Outer Box



\*Material: Paper(SW3B(B))

TYPE	SIZE(mm)		
	Ⓐ	Ⓑ	ⓒ
7inch	245	220	142



## 10. Precaution for use

### (1) Storage

In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desiccator) with a desiccant . Otherwise, to store them in the following environment is recommended.

Temperature : 5℃~30℃    Humidity : 60%HR max.

### (2) Attention after opened

However LED is correspond SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed.

a. After opened and mounted, the soldering shall be quickly.

b. Keeping of a fraction

Temperature : 5 ~ 40℃    Humidity : less than 30%

(3) In case of more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at 60±5℃.

(4) In case of supposed the components is humid, shall be dried dip-solder just before.

100Hr at 80±5℃ or 12Hr at 100±5℃.

(5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.

(6) Quick cooling shall not be avoid.

(7) Components shall not be mounted on warped direction of PCB.

(8) Anti radioactive ray design is not considered for the products listed here in.

(9) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.

(10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

(11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(12) The LEDs must be soldered within seven days after opening the moisture-proof packing.

(13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.

(14) The appearance and specifications of the product may be modified for improvement without notice.

10. RoHS

  
**Korea Environment & Merchandise Testing Institute**  
 459-28 GASAN-DONG, GEUMCHEON-GU, SEOUL, KOREA  
 TEL : 82-2-2102-2500 FAX : 82-2-856-5618 http://www.kemti.org

**TEST REPORT**

No. : 18570 Date Out : JUN. 28, 2005  
 Client : SEOUL SEMICONDUCTOR CO., LTD. Date In : JUN. 21, 2005  
 Address : #148-29, Gasan-dong, Geumcheon-gu, Seoul, Korea Test Date : JUN. 28, 2005  
 Buyer : LS INDUSTRIAL SYSTEM CO., LTD.  
 Sample Description : TWH104-H  
 Test Results : Refer to the next page

Signed by \_\_\_\_\_  
 Kyung Hwan Yu, Manager  
 Env. Testing Department

Our report apply only to the standards or procedures identified and to the sample(s) tested unless otherwise specified.  
 The test results are not indicative of representative of the qualities of the lot from which the sample was taken or of  
 apparently identical or similar products.

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No. : 18570

[TEST RESULT]

Items	Unit	Test Results	Test Methods
Lead(Pb)		Not detected (Detection limit 2)	USEPA 3051 Analytical instrument : ICP-AES
Cadmium(Cd)	mg/kg	Not detected (Detection limit 1)	USEPA 3051 Analytical instrument : ICP-AES
Mercury(Hg)		Not detected (Detection limit 1)	USEPA 3051 Analytical instrument : ICP-AES
Chromium VI(Cr <sup>6+</sup> )	μg/EA	Not detected (Detection limit 0.1)	ISO 3613:2000(E) UV-Vis. Spectrophotometer
Polybrominated Biphenyls(PBBs)			
Bromobiphenyl		Not detected (Detection limit 1)	GC-MS analysis
Dibromobiphenyl		Not detected (Detection limit 1)	
Tribromobiphenyl		Not detected (Detection limit 1)	
Tetrabromobiphenyl		Not detected (Detection limit 1)	
Pentabromobiphenyl	mg/kg	Not detected (Detection limit 1)	
Hexabromobiphenyl		Not detected (Detection limit 1)	
Heptabromobiphenyl		Not detected (Detection limit 1)	
Octabromobiphenyl		Not detected (Detection limit 1)	
Decabromobiphenyl		Not detected (Detection limit 1)	
Polybrominated Diphenyl Ethers(PBDEs)			
Bromodiphenyl ether		Not detected (Detection limit 1)	GC-MS analysis
Dibromodiphenyl ether		Not detected (Detection limit 1)	
Tribromodiphenyl ether		Not detected (Detection limit 1)	
Tetrabromodiphenyl ether		Not detected (Detection limit 1)	
Pentabromodiphenyl ether	mg/kg	Not detected (Detection limit 1)	
Hexabromodiphenyl ether		Not detected (Detection limit 1)	
Heptabromodiphenyl ether		Not detected (Detection limit 1)	
Octabromodiphenyl ether		Not detected (Detection limit 1)	
Nonabromodiphenyl ether		Not detected (Detection limit 1)	
Decabromodiphenyl ether		Not detected (Detection limit 1)	

◆ Rank Division

Iv [mcd] (I <sub>F</sub> =5 mA)	Color coordinate (I <sub>F</sub> =5 mA)	VF [V] (I <sub>F</sub> =5 mA)	Rank	Product
C	A	A	CAA	
C	A	B	CAB	
C	A	C	CAC	
C	A	D	CAD	
D	A	A	DAA	
D	A	B	DAB	
D	A	C	DAC	
D	A	D	DAD	
C	B	A	CBA	
C	B	B	CBB	
C	B	C	CBC	
C	B	D	CBD	
D	B	A	DBA	
D	B	B	DBB	
D	B	C	DBC	
D	B	D	DBD	
C	C	A	CCA	
C	C	B	CCB	
C	C	C	CCC	
C	C	D	CCD	
D	C	A	DCA	
D	C	B	DCB	
D	C	C	DCC	
D	C	D	DCD	
C	D	A	CDA	
C	D	B	CDB	
C	D	C	CDC	
C	D	D	CDD	
D	D	A	DDA	
D	D	B	DDB	
D	D	C	DDC	
D	D	D	DDD	

 SSC-TWH104-HS  
 SSC-TWH104-HL